SURFBOARDS

THE BREADBOARDING MEDIUM FOR SURFACE MOUNT TAM



33000 SERIES APPLICATION SPECIFIC ADAPTERS

IDS33408

33408 MODEL

ACCEPTS

PARTIAL LISTING

ON SEMI

ULLGA8 1.6x1.0,0.4P UDFN8 1.8x1.2,0.4P

TEXAS INST.

DQM (R-PX2SON-N8)

ALWAYS CONSULT DEVICE DATA SHEET TO INSURE PROPER FIT

Feature Pins on .1 in. Centers designed for use with Solderless breadboards, Conventional Breadboards, and Sockets with standard .1 in. centers.

Use For Prototyping, Device Test or Evaluation and SMD to Through Hole Conversion.

JUST ADD PARTS AND PLUG-IN ™

FIG.	ММ	IN.	NOTE:
Α	20.32	.800	BOARD WIDTH +5mm .020in.
В	8.89	.350	BOARD HEIGHT +5mm .020in.
С	2.54	.100	SIP PIN SPACE +20mm .008in.
D	1.7	.067	PAD CENTERLINE
Е	.4	.016	DEVICE LEAD PITCH
F	1.5	.059	PAD LENGTH
G	.25	.010	PAD WIDTH
Н	.2	.008	GAP
ı	2.8	.110	MAX LEAD WIDTH
J	1.0	.039	TYPICAL LEAD WIDTH
Р	3.3	.130	LENGTH FROM SHOULDER +5mm .020in.
S	1.57	.062	PIN SHOULDER HEGHT
W	.5	.020	PIN WIDTH

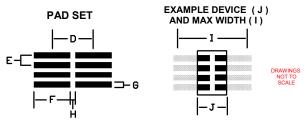
TOLERANCES: If not noted are +- 20%. Nominal values are given. Controlling unit is Millimeters Values rounded to nearest decimal. Slight Variations due to manufacturing process can occur.

8 LEAD .4 mm PITCH DEVICES

DEVICE LEAD WIDTH 1.0, 1.2, To Max 2.5 MM

33408 В S

SINGLE-IN-LINE (SIP) PINS ON .100 in. CENTERS



MOUNTING PADS ARE OVERSIZED IN LENGTH TO ACCEPT A WIDER RANGE OF DEVICE WIDTHS AND TOLERANCES AND TO PERMIT HAND SOLDERING. SEE WEBSITE FOR SOLDERING SUGGESTIONS

BOARD SPECIFICATIONS

BOARD MATERIAL: .8mm, +-.13mm .031in+-..005 in. Thick G-10 FR-4 Glass Epoxy or equivalent.

CIRCUITS: 1 oz. Copper with RoHS compliant Lead Free solder coating. Patten Position on board +- .5mm .020in.

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